TOSHIBA ALLOY-FREE THYRISTOR

## S F 5 O O E X 2 9

HIGH POWER CONTROL APPLICATIONS

Repetitive Peak Off-State Voltage :  $V_{DRM}$  = 2500V

Repetitive Peak Reverse Voltage

Average On-State Current  $: I_{T(AV)} = 500A$ 

Turn-Off Time :  $t_0 = 400 \mu s$  (Max.)

Critical Rate of Rise of On-State Current

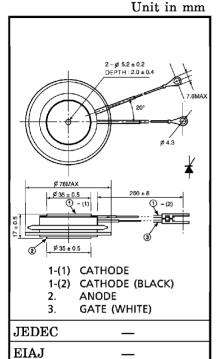
:  $di/dt = 200A/\mu s$ 

Critical Rate of Rise of Off-State Voltage

:  $dv/dt = 500V/\mu s$ 

Weight : 250g

Flat Package



13-78F1A

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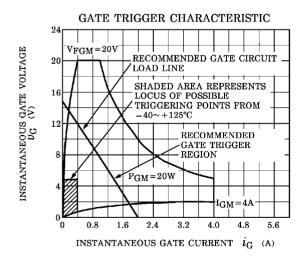
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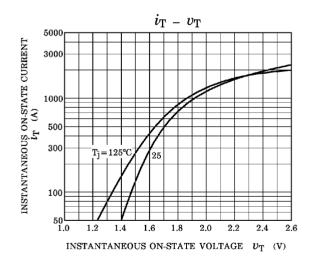
## **MAXIMUM RATINGS**

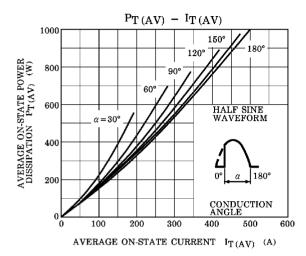
CHARACTERISTIC	SYMBOL	RATING	UNIT	
Repetitive Peak Off-State Voltage and Repetitive Peak Reverse Voltage	$v_{ m DRM}$ $v_{ m RRM}$	2500	V	
Non-Repetitive Peak Reverse Voltage (Non-Repetitive $< 5 \text{ms}, T_j = 0 \sim 125 ^{\circ}\text{C}$ )	$v_{ m RSM}$	2750	V	
R.M.S On-State Current	IT (RMS)	785	Α	
Average On-State Current	I <sub>T</sub> (AV)	500	A	
Peak One Cycle Surge On-State Current (Non-Repetitive)	I <sub>TSM</sub>	7200 (50Hz) 8000 (60Hz)	A	
I <sup>2</sup> t Limit Value	${f I^2 t}$	$250 \times 10^{3}$	$\mathbf{A}^2\mathbf{s}$	
Critical Rate of Rise of On-State Current (Note)	di / dt	200	A/μs	
Peak Gate Power Dissipation	PGM	20	W	
Average Gate Power Dissipation	P <sub>G</sub> (AV)	4	W	
Peak Forward Gate Current	I <sub>GM</sub>	4	Α	
Peak Forward Gate Voltage	$v_{ m FGM}$	20	V	
Peak Reverse Gate Voltage	$v_{RGM}$	5	V	
Junction Temperature	$T_{j}$	-40~125	$^{\circ}\mathrm{C}$	
Storage Temperature Range	$\mathrm{T_{stg}}$	-40~125	$^{\circ}\mathrm{C}$	
Mounting Force	_	14.7±1.5	kN	

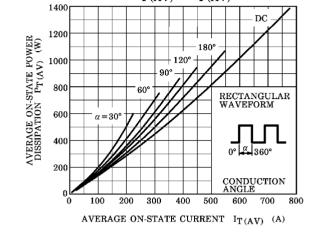
## **ELECTRICAL CHARACTERISTICS**

CHARACTERISTIC	SYMBOL	TEST CONDITION		MIN.	MAX.	UNIT
Repetitive Peak Off-State Current and Repetitive Peak Reverse Current	IDRM I <sub>RRM</sub>	$V_{ m DRM} = V_{ m RRM} = { m Rated}$ $T_{ m j} = 125 { m ^{\circ}C}$		_	50	mA
Peak On-State Voltage	$V_{ extbf{TM}}$	$I_{TM} = 1600A, T_j = 25$ °C			2.16	V
Gate Trigger Voltage	$v_{ m GT}$	W6W B60	$T_j = -40^{\circ}C$ $T_j = 25^{\circ}C$	0.6	4.5 2.5	V
Gate Trigger Current	$I_{\mathrm{GT}}$	$V_{D}$ =6V, $R_{L}$ =6 $\Omega$	$T_j = -40^{\circ}C$ $T_j = 25^{\circ}C$	 15	400 250	mA
Gate Non-Trigger Voltage	$v_{ m GD}$	$V_D=1/2$ Rated, $T_j=115$ °C		0.2	_	V
Gate Non-Trigger Current	$_{ m IGD}$			5		mA
Delay Time	$^{\mathrm{t}}\mathrm{d}$	$egin{aligned} & V_D\!=\!1/2 \;  ext{Rated}, \; T_j\!=\!25^\circ\! ext{C} \ &  ext{Gate Supply} \ & (V_G\!=\!15V, \; R_G\!=\!8\Omega, \; t_r\!\leq\!1\mu\text{s}) \end{aligned}$		_	4	$\mu$ s
Gate Turn-On Time	$t_{ m gt}$			_	6	μs
Turn-Off Time	$\mathbf{t_q}$	$I_T$ =800A, $V_R$ \geq 50V $dv/dt$ =20V/ $\mu$ s, $T_j$ =120°C $V_{DRM}$ =1/2 Rated		_	400	μs
Holding Current	${ m I_H}$	$T_j=25$ °C, $R_L=6\Omega$			300	mA
Critical Rate of Rise of Off-State Voltage	dv / dt	V <sub>DRM</sub> =2/3 Rated, T <sub>j</sub> =125°C Gate Open, Exponential Rise		500	_	V/μs
Thermal Resistance (Junction to Case)	$ m R_{th~(j-f)}$	DC		_	0.04	°C/W









 $P_{T(AV)} - I_{T(AV)}$ 

